# A 45-nm SOI-CMOS Dual-PLL **Processor Clock System** for Multi-Protocol I/O

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## Outline

#### Introduction

- Architecture and Circuits
  - Ring-based PLL
  - LC-based PLL
- Silicon Results
- Conclusion

# The Vision

- I/O connectivity for integrated CPU+GPU
  - PCI Express® (PCIe) 1.1 & 2.0
  - DisplayPort<sup>™</sup> (DP), DVI<sup>™</sup>, HDMI<sup>™</sup>



## **Multi-Protocol Requirements**

- Wide range of operating modes
  - $f_{ref} = 50 450 \text{ MHz} \rightarrow f_{out} = 125 2500 \text{ MHz}$
  - 2-4 MHz BW @ < 2 dB Peaking
  - 5 8 MHz *BW* @ < 1 dB *Peaking*
  - 8 16 MHz *BW* @ < 3 dB *Peaking*
- Strict PLL phase jitter requirements < 1.0 1.5 ps rms
- Fast exit (< 5 µs) from power-down/sleep modes for low-power client applications

# **Design Challenges**

- Partially-depleted (PD) SOI noise concerns
  - More FET noise than bulk from floating body and high-resistance body ties
  - More difficult to predict jitter since RF simulators cannot handle floating-body devices correctly



- PVT variation + mismatch  $\rightarrow$  large BW variation
  - e.g., 3x VCO gain variation
- Noisy operating environment
  - Multi-core CPU + graphics + memory controller

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## **Dual-PLL Architecture**



- Low-jitter *LC*-PLL for PCIe 2.0 (narrow tuning range)
- Higher-jitter **Ring-PLL** for all other modes (wide tuning range)
- 10% area overhead for dual-PLLs (many shared circuits)
- Voltage regulators (from 2.5 V) to reduce power-supply noise

# **Ring-PLL – Dual-Path VCO Control**

- High-BW / low-gain path (V<sub>control</sub>)
  - Sets PLL bandwidth
  - Conventional 2-pole / 1-zero
  - Effective  $K_{VCO} \downarrow \rightarrow$  jitter  $\downarrow$ (70% less jitter contribution from loop-filter resistor and charge-pump)
- Low-BW / high-gain path (V<sub>slow</sub>)
  - Sets VCO "center" frequency
  - $BW(V_{slow}) < 0.2\% \times BW(V_{control})$
  - Contributes negligible jitter
  - Bypass *R*<sub>slow</sub> during *fastlock* mode (pay attention to stability)
  - *IR* drop across  $R_{slow}$  due to leakage < 15 mV limits *BW* ( $V_{slow}$ )



# **Ring-PLL – Slow-Path Jitter Analysis**

 Low-pass filter shapes noise to control jitter

• 
$$V_n \propto \frac{1}{C_{slow}\sqrt{R_{slow}}}$$

- For constant *RC*, get lower jitter with larger C<sub>slow</sub> but area penalty
- $R_{slow}$  = 600 k $\Omega$  and  $C_{slow}$  = 20 pF
- Negligible slow-path jitter
  - Slow-path jitter < 75 fs</li>
  - Fast-path jitter < 400 fs
  - VCO jitter < 1000 fs



# **Ring-PLL – VCO Design**

- Dual-control path for lower effective gain
- Body-tied MOSFETs for jitter reduction and ability to simulate → 2x speed penalty
- 5-stage Ring-oscillator VCO
  - 5 stages for easier oscillation
  - Cross-coupled inverters for fast slew rates and level shifting
- Source degeneration in current bias for noise reduction
- Amplifier in bias circuits to improve supply noise rejection
- Divide-by-2  $\rightarrow$  50% duty-cycle



# **Body-Tied PD-SOI MOSFET (T-Gate)**

- Enables body connection to undepleted FET well
- High  $R_{body}$  and extra  $C_{gate}$  limits BW of body connection
- NMOS example p+ Poly gate SOI active island p<sup>+</sup> diffusion p<sup>+</sup> body-tie n+ n+ Lateral connection to  $\boxtimes$  $\boxtimes$ undepleted p-well n+ n+  $\boxtimes$  $\boxtimes$ drain source 🖌 p-well  $\boxtimes$  $\boxtimes$ body node n<sup>+</sup> diffusion

# **Ring-PLL – VCO Gain Calibration**

- PLL in closed-loop operation with *fastlock* asserted
- Algorithm reduce Kv[3:0] until  $V_{control} > V_{ref}$
- DecrementKv Result R-ladder M=Kv[3:0] •  $K_{vco}$  variation across ≹ **V**<sub>ref</sub> M=8 ♀ **Finite** PVT reduced by 43% State ≷ **V**<sub>RO</sub> More constant I<sub>bias</sub> Machine **V**<sub>control</sub>  $\rightarrow$  15% less jitter **R**<sub>zero</sub>≱ **FSMclk** ‡C₂  $\rightarrow$  9 dB lower ref spurs C₁≑ 3x **V**<sub>slow</sub> Ring fastlock = 1  $\neq C_{slow}$ VCC

#### **Bandwidth and Peaking Measurements**

- Algorithm based on Fischette et al., CICC 2009
  - Apply instantaneous half-period phase step by inverting *RefClk*
  - Measure  $\tau_{crossover}$  ( $\rightarrow$  *BW*) and *MaxOvershoot* ( $\rightarrow$  *Peaking*)



# LC-PLL – 10 GHz LC-VCO Design

- Lower jitter than ring-VCO
- 29% tuning range
- Tune at 4x required frequency for smaller *L* and 50% duty cycle
- Low VCO gain
  → No slow path required
- Floorplan to avoid magnetic coupling from switching currents in surrounding circuits and supply bumps



# LC-PLL – VCO Elements

- Body ties for gain and tail devices
  - Narrow widths for higher *BW* connectivity
  - Lower channel and upconverted 1/f noise
  - Tuning range penalty from T-gate load
- Differential inductor
  - M11 turns with M10-M09-M08 underpass
  - Extensive dummy metal fill for CMP manufacturability
- Varactors
  - Accumulation mode n-well for good Q
  - Thick oxide for low Igate



# **LC-PLL – Coarse-Tuning Calibration**

- VCO coarse-tuned by 5-bit DAC, steps frequency by 0.5 0.8%
- Calibrate VCO using *RefClk* and PLL feedback clock counters
- RefClk has up to 0.5% spread spectrum frequency modulation
- Count over one 33 kHz spread spectrum period to desensitize calibration from modulation phase and preserve post-calibration tunability, otherwise risk non-monotonic calibration code



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#### **Measured Phase Noise at 2.5 GHz**



### **RMS Jitter Distributions at 2.5 GHz**



- 1 MHz 1.25 GHz integration window
- 27 parts (includes  $V_T$  and resistor skew wafers)

### **Die Photograph**



## **Performance Summary**

Parameter		Ring-PLL	LC-PLL
Technology		45 nm SOI-CMOS (36 nm $L_{gate}$ )	
VCO Lock Range		1.0 – 8.5 GHz	8.3 – 11.1 GHz
RMS Jitter	Mean ± 3σ	975 ± 85 fs	536 ± 76 fs
Phase Noise	At 1 MHz Offset	–106.6 dBc/Hz	–112.1 dBc/Hz
	At 10 MHz Offset	–114.9 dBc/Hz	–123.4 dBc/Hz
Reference Spur	At 100 MHz Offset	–58.4 dBc	–61.8 dBc
Jitter Transfer	-3 dB Bandwidth	6.6 MHz	6.6 MHz
	Peaking	0.41 dB	0.54 dB
Supply Consumption	Current	28 mA	24 mA
	Voltage	1.8 – 2.7 V (2.5 V nom)	

# Conclusion

- Designed dual-PLL system for clocking multi-protocol wireline I/O in 45-nm SOI-CMOS processors
- Presented circuit and architectural techniques to minimize impact of PD-SOI floating-body and PVT variations
- Exceeded multi-protocol requirements
  - 1.0 11.1 GHz VCO lock range
  - 975±85 fs rms jitter for ring-based PLL
  - 535±76 fs rms jitter for *LC*-based PLL

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#### Thank you for your attention!